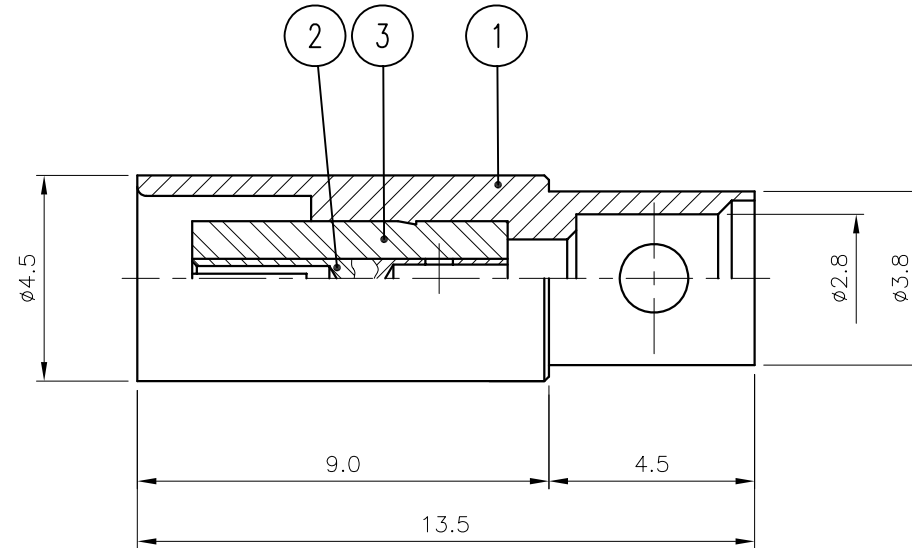
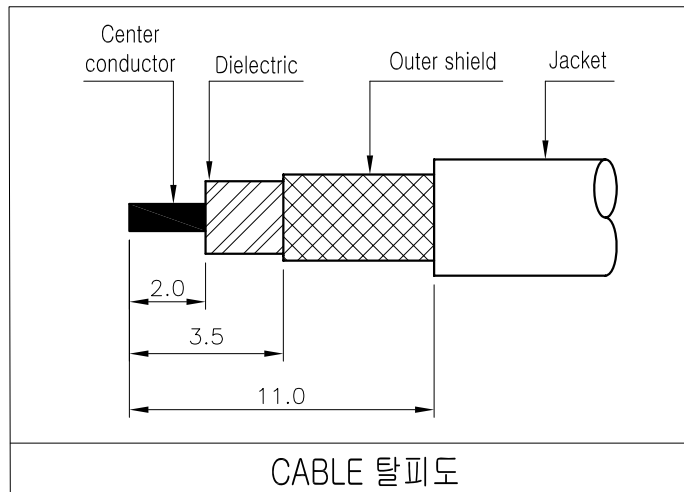


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2017.10.26.



조립방법

1. 아래 치수대로 케이블 탈피 후 핀+심선 납땜 작업
2. 솔드의 경우 디핑처리하지 않고 $\phi 0.4$ 납을 감아서 바디와 납땜 작업



3	INSULATOR	1	TEFLON		DIN02951-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03890-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04360-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2017. 10. 26.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017			
	Angle	APPROVED BY						
	±0.2							
MATERIAL	±1°	CHECKED BY			TITLE HMC50 CABLE JS Shikoku 1.5DS-QEHB			
	_____	DRAWN BY I.C.KIM						
FINISH	_____	SCALE	UNIT		A4	DWG NO.	CN03739-7/2	
	_____	6/1	mm			REVISION	I R	SHEET